

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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July 2016

Chip beads

For general signal line

MMZ series

 $MMZ2012_{\,\text{Type}}$

MMZ2012

2012[0805 inch]*

* Dimensions code JIS[EIA]

Reminders for using these products

Before using these products, be sure to request the delivery specifications.

Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

Reminders The storage period is less than 12 months.Be sure to follow the storage conditions (temperature:5 to 40°C, humidity:10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. On not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.). Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C. Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur. When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions. Oself heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design. Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. Use a wrist band to discharge static electricity in your body through the grounding wire. On not expose the products to magnets or magnetic fields. On Do not use for a purpose outside of the contents regulated in the delivery specifications. The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions



Chip beads

For general signal line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of MMZ2012 type

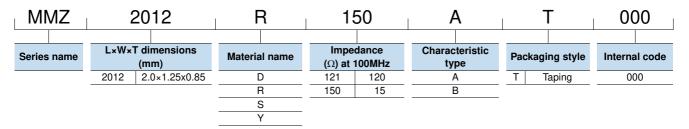
FEATURES

- O Noise reduction solution for general signal line.
- Ovarious frequency characteristics with 4 materials of different features for countermeasures against everything from general signals to high-speed signals.

APPLICATION

- O Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.
- O Noise removal for PCs and recorders, household appliances such as STBs, smart grids, and industrial equipment.

■ PART NUMBER CONSTRUCTION



■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperature ranges		Package quantity	Individual weight
Туре	Operating temperature	Storage temperature*		
	(°C)	(°C)	(pieces/reel)	(mg)
MMZ2012	-55 to +125	-55 to +125	4,000	8

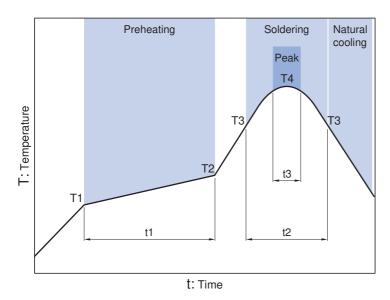
^{*} The storage temperature range is for after the circuit board is mounted.

OROHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



■ RECOMMENDED REFLOW PROFILE



Preheating Soldering Peak Temp. Temp. Temp. Time Time Time T1 T2 Т3 **T4** 150°C 180°C 60 to 120s 230°C 30 to 60s 250 to 260°C 10s



■ MATERIAL CHARACTERISTIC

R material: for wide frequency applications calling for broad impedance characteristics. For digital signal line applications calling requiring good waveform integrity. Impedance values selected for effectiveness at 10 to 200MHz.

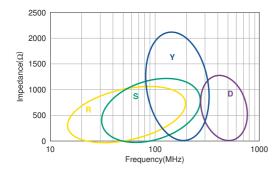
S material: Standard type that features impedance characteristics similar to those of a typical ferrite core. For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

Y material: High frequency range type intended for the 100MHz region and above. For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies.

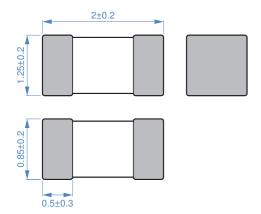
Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS





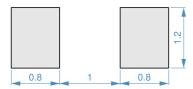
SHAPE & DIMENSIONS





Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm



ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

15 : 30 :	Tolerance ±25% ±25% ±25%	(Ω)max. 0.05 0.05	(mA)max.	MMZ2012R150AT000
15 : 30 :	±25% ±25% ±25%	0.05 0.05	1500	MMZ2012R150AT000
30 :	±25% ±25%	0.05		MMZ2012R150AT000
	±25%		4=00	
60			1500	MMZ2012R300AT000
		0.10	1000	MMZ2012R600AT000
120 :	±25%	0.12	800	MMZ2012R121AT000
300	±25%	0.15	600	MMZ2012R301AT000
600	±25%	0.20	500	MMZ2012R601AT000
1000	±25%	0.30	500	MMZ2012R102AT000
40	±25%	0.10	1000	MMZ2012S400AT000
80	±25%	0.10	800	MMZ2012S800AT000
120 :	±25%	0.15	800	MMZ2012S121AT000
180	±25%	0.15	600	MMZ2012S181AT000
300 :	±25%	0.20	600	MMZ2012S301AT000
600	±25%	0.30	500	MMZ2012S601AT000
1000 :	±25%	0.35	500	MMZ2012S102AT000
15 :	±25%	0.05	1500	MMZ2012Y150BT000
30 :	±25%	0.05	1500	MMZ2012Y300BT000
60	±25%	0.10	1000	MMZ2012Y600BT000
120 :	±25%	0.12	800	MMZ2012Y121BT000
300	±25%	0.15	600	MMZ2012Y301BT000
600	±25%	0.20	500	MMZ2012Y601BT000
1000	±25%	0.30	500	MMZ2012Y102BT000
1500 :	±25%	0.40	500	MMZ2012Y152BT000
2000	±25%	0.50	400	MMZ2012Y202BT000
80 :	±25%	0.30	500	MMZ2012D800BT000
120	±25%	0.30	500	MMZ2012D121BT000
300	±25%	0.50	400	MMZ2012D301BT000

$\bigcirc \ \text{Measurement equipment}$

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

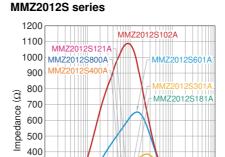
^{*} Equivalent measurement equipment may be used.



ELECTRICAL CHARACTERISTICS

□Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MMZ2012R series 1200 MMZ2012R102A 1100 MMZ2012R601A MMZ2012R121 1000 MMZ2012R600A 900 MMZ2012R300A 800 Impedance (Ω) 700 600 500 400 300 200 100 10000 100 Frequency (MHz)



100

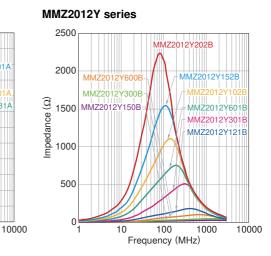
Frequency (MHz)

1000

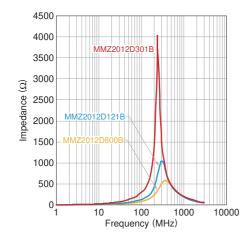
300

200

100



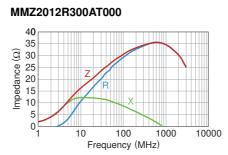
MMZ2012D series

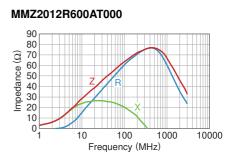


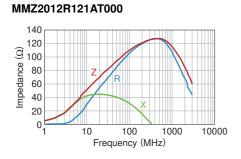
ELECTRICAL CHARACTERISTICS

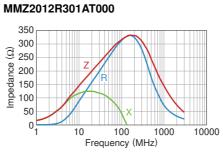
Z, X, R VS. FREQUENCY CHARACTERISTICS

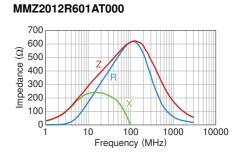
MMZ2012R150AT000 25 0 0 15 0 10 10 100 1000 10000 Frequency (MHz)

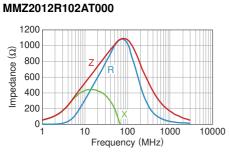


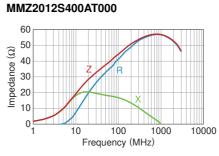


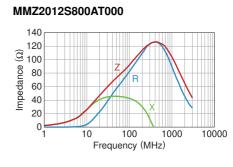


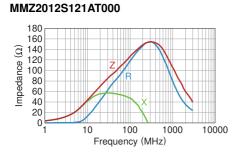


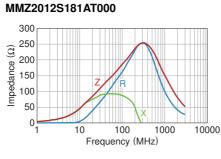


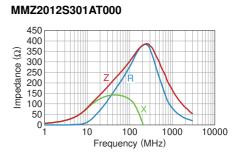


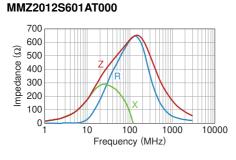


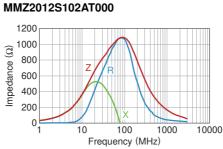


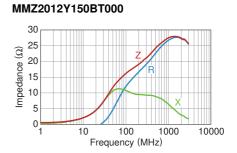












A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.



MMZ2012Y300BT000

ELECTRICAL CHARACTERISTICS

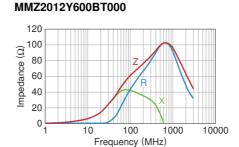
Z, X, R VS. FREQUENCY CHARACTERISTICS

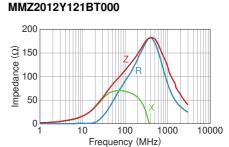
1000

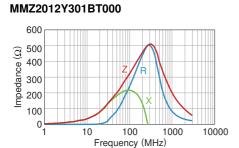
10000

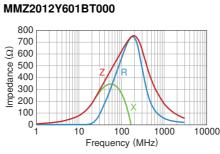
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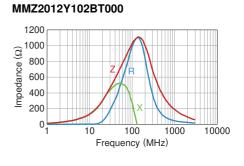
Frequency (MHz)

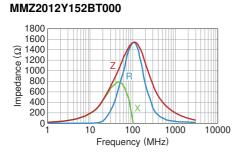


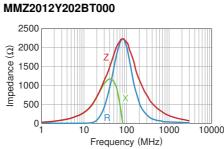


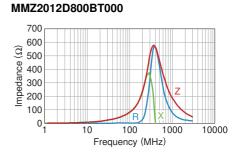


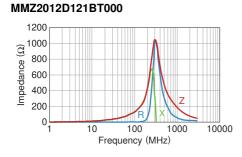


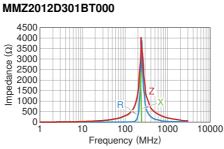










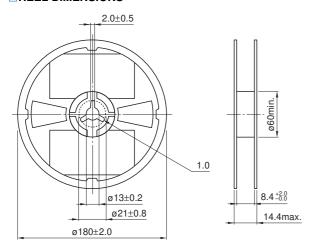


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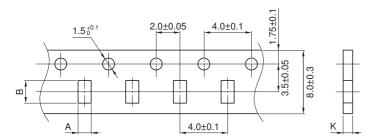
■PACKAGING STYLE

REEL DIMENSIONS



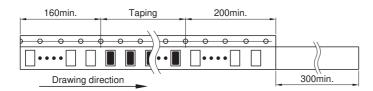
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	P1	K
MMZ2012	1.5±0.2	2.3±0.2	4.0±0.1	1.1max.



Dimensions in mm

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